Form PTO-1595		rtment of Commerce		
6-93  OMB No 0651-0011 (exp 4/94)  Patent and Trademark Office				
To the Honorable Commissioner of Patents and Trademarks. Please record the atta		o La		
Name of conveying party(ies):	Name and address of receiving party(ies):     Name: LSI Logic Corporation	u.s. 32125		
Charles E. May Hemanshu Bhatt	Street Address: 1551 McCarthy Boulevard	10/		
Additional name(s) of conveying party(ies) attached? [ ] Yes [ X ] No  3. Nature of Conveyance:	City: Milpitas, California ZIP 95035  Country: United States of America Additional name(s) & address(es) attached?	Yes [X] No		
X   Assignment				
4. Application number(s) or patent number(s):				
If this document is being filed together with a new application, the execution date of the application is <u>08/29/2001</u> , <u>09/18/2001</u> .				
A. Patent Application No(s):	B. Patent No(s)			
Additional numbers attached? [ ] Yes [X] No				
Title of Invention: Semiconductor Wafer Arrangement and Method of Processing a Semiconductor Wafer LSI Logic Docket No.: 01-145/1D  Our Docket No.: 1003-0630				
Name and address of party to whom correspondence concerning documents should be mailed:	6. Total number of applications and patents involved $\frac{1}{2}$			
Name: Sandeep Jaggi	7. Total fee (37 CFR §3.41): .\$ <u>40.00</u>			
Internal Address: LSI Logic Corporation Intellectual Property Department M/S D-106				
Street Address: 1551 McCarthy Boulevard City: State: Zip: Milptas, California 95035		2-2252		
DO NOT US	(Attach duplicate copy of this page if paying by deposit as SE THIS SPACE	ccount)		
DO NOT USE THIS SPACE				
9. Statement and signature.  To the hest of my knowledge and belief, the foregoing information is copy of the original document.  Harold C. Moore  Name of Person Signing  Registration No. 37,982	December 16, 2 Date total number of pages including cover sheet, attachm			
00000140 122232 19321239 Commissioner of Patents and	th required cover sheet information to: d Trademarks, Box Assignments on, D.C. 20231			

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> PATENT REEL: 013598 FRAME: 0310

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MAGINOT ADDISON & mi E

Docket No. 01-145

PATENT

## **ASSIGNMENT**

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/WE, the undersigned, Charles E. May and Henanshn Bhatt, do hereby sell, assign, and transfer to: LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1551 McCarthy Boulevard, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Paters.

disclosed in the ap	oplication for United Sta	iles Leiters Paleti.
( <b>x</b> )	which has been execut	and assigned Serial No.
( )	mpich was thed ou	and assigned Serial (Vo.
to said application Patent which have and in and to all	n and all divisional, con the been or shall be filed in original and reissued p on said improvements;	trangement and Method of Processing a Semiconductor Wafer" and in and minuting, substitute, renewal, reissue, and all other applications for Letters in the United States and all foreign countries on any of said improvements; patents which have been or shall be issued in the United States and all and in and to all rights of priority resulting from the filing of said United
that, when requestrepresentatives, at all divisional, co- improvements; or Assignee, its sta- improvements and assignee or representations and assigns or representations and improvements and improvements.	sted, without charge to be carry out in good faith ontiming, substitute, re- secute all rightful ouths coessors, assigns, and d the history thereof; a contatives shall consider ments and for vesting ti-	r and receive Letters Patent for said improvements in its own name; and of but at the expense of, said Assignee, its successors, assigns and legal in the intent and purpose of this Assignment, the undersigned will execute enewal, reissue, and all other patent applications on any and all said assignments, powers of attorney and other papers; communicate to said representatives, all facts known to the undersigned relating to said and generally do everything possible which said Assignee, its successors, desirable for aiding in securing and maintaining proper patent protection into a said improvements and all applications to patents and all patents on successors, assigns and legal representatives; and
license or other	agreement affecting th	sors, assigns and legal representatives that no assignment, grant mortgage, the rights and property herein conveyed has been made to others by the same as herein expressed is possessed by the undersigned.
Name:	<i>0</i> 23	Date: 8-2501 Witness: Louna Hooper
Charles	2. May	Witness: Donna Hooper
*		Printed Name
** * *		
Name:		Date: , 2001 Witness:
Henansh	n Bhart	
		Witness: Printed Name
•		Stitted water
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War and		

Assignment

PATENT REEL: 013598 FRAME: 0311 (X)

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which was filed on

## ASSIGNMENT

and assigned Serial No.

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/WE, the undersigned, Charles E. May and Hemanshu Bhatt, do hereby sell, assign, and transfer to: LSI LOGIC CORPORATION, a corporation of Delaware, having a place of business at 1551 McCarthy Boulevard, Milpitas, California 95035, ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements which are disclosed in the application for United States Letters Patent,

which has been executed by the undersigned concurrently herewith,

and is entitled: "Semiconductor Wafer Arrangement and Method of Processing a Semiconductor Wafer" and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and
Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications to patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and
Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.
Name: Date:, 2001Witness:
Charles E. May Witness:
Printed Name
Name: Date: 9/18/, 2001 Witness: Scott Mc Gove D  Witness: Scott M. Gove D  Printed Name
Frince Pane

Assignment

**RECORDED: 12/16/2002** 

PATENT REEL: 013598 FRAME: 0312